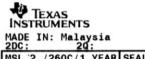
PCN	Num	iber:	201	9110	1000.	1A					PO	CN D	ate:	Dec.	27 2019
Title	e:	Qualific	ation	of CD	OAT as	an a	additiona	al asse	mbly site f	or se	elect	t QFN	devic	es	
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Cont	tinuity	of Sup	ply												
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None	<u></u>	<u>-</u>			<u>-</u>	-		<u> </u>							
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## Changes to product identification resulting from this PCN:

Assembly Site	Assembly Site Origin (22L)	Assembly Country Code (23L)	Assembly City
MLA	MLA	MYS	<del>Chengdu</del> <mark>Kuala Lumpur</mark>
CLARK	QAB	PHL	Angeles City, Pampanga
CDAT	CDA	CHN	Chengdu

Sample product shipping label (not actual product label)



MSL 1 /235C/UNLIM 03/29/04

DPT: 39 LBL: 5A (L)T0:1750



(1P) \$N74L\$07N\$R (Q) 2000 (D) 0336 (31T)LOT: 3959047MLA (4W) TKY(1T) 7523483812

(2P) REV: (V) 0033317 (20L) CSO: SHE (21L) CCO:USA (22L) ASO: MLA (23L) ACO: MYS

## **Product Affected:**

**Group 1 Device List (Current MLA Assembly, add CDAT):** 

74AVC8T245RHLRG4	TPS2115ADRBR	TPS63000DRCR	TPS63001DRCRG4
HPA00720RHLR	TPS2115ADRBT	TPS63000DRCRG4	TPS63001DRCT
SN74AVC8T245RHLR	TPS2115ADRBTG4	TPS63000DRCT	TPS63002DRCR
TPS2113ADRBR	TPS53321RGTR	TPS63000DRCTG4	TPS63002DRCT
TPS2113ADRBT	TPS53321RGTT	TPS63001DRCR	TPS63002DRCTG4

**Group 2 Device List (Current MLA Assembly & Clark, add CDAT):** 

TPS74801DRCR	TPS74801RGWR	TPS74801RGWTG4	TPS74901RGWR
TPS74801DRCRG4	TPS74801RGWRG4	TPS74901DRCR	TPS74901RGWT
TPS74801DRCT	TPS74801RGWT	TPS74901DRCT	TPS74901RGWTG4
TPS74801DRCTG4			

**Group 3 Device List (Current MLA Assembly, add CDAT):** 

TPS62162DSGR	TPS62162DSGT	TPS62172DSGR	TPS62172DSGT
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## **Group 4 Device List (Current MLA Assembly, add CDAT):**

SN14	09030RUKR	TPS51916RUKR	TPS51916RUK	T

# **Group 1 Qual Memo:**



TI Information Selective Disclosure

#### **Qualification Results** Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: E58T245RHLR	QBS Package Reference: <u>BQ24196RGER</u>	QBS Package Reference: BQ29200DRBR	QBS Package Reference: SN74AXC8T245RHLR	QBS Package Reference: TP \$3850G09DRC	QBS Package Reference: TPS62140RGTR	QBS Package Reference: TRS3122ERGER	QBS Package Reference: UCC27282DRC
AC	Autoclave 121C	96 Hours	-	3/231/0	3/231/0	-	3/231/0	3/231/0	3/231/0	3/231/0
ED	Electrical Characterization	Per Datasheet Parameters	-	-	-	Pass	Pass	Pass	Pass	Pass
FLAM	Flammability (IEC 695-2-2)								3/15/0	
FLAM	Flammability (UL 94V-0)								3/15/0	
FLAM	Flammability (UL-1694)								3/15/0	
HAST	Biased HAST, 110C/85%RH	26 Hours	-	-	-	-	-	-	-	1/77/0
HAST	Biased HAST, 130C/85%RH	96 Hours	-	-	-	-	3/231/0	-	3/231/0	2/154/0
HTOL	Life Test, 140C	480 Hours	-	-	-	-	-	-	-	3/231/0
HTOL	Life Test, 150C	300 Hours	-	-	-	-	1/77/0	-	1/77/0	-
HTSL	High Temp Storage Bake 150C	1000 Hours	-	-	-	3/231/0	-	-	3/231/0	3/231/0
HTSL	High Temp Storage Bake 170C	420 Hours	-	-	-	-	3/231/0	-	-	-
SD	Surface Mount Solderability	Pb Free							1/22/0	
TC	Temperature Cycle, -65/150C	500 Cycles	3/231/0	3/231/0	3/231/0	3/231/0	3/231/0	3/231/0	3/231/0	3/231/0
UHAST	Unbiased HAST 130C/85%RH	96 Hours	-	-	-	3/231/0	-	-	-	-
WBP	Bond Pull	Wires	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0
WBS	Ball Bond Shear	Wires	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0

<sup>-</sup> QBS: Qual By Similarity
- Qual Device E58T245RHLR is qualified at LEVEL1-260CG
- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTDL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47: 55C/125C/700 Cycles and-65C/150C/500 Cycles
- Quality and Environmental data is available at Ti's external Web site: http://www.ti.com/
- Green/Pb-free Status:
- Qualified Pb-Free(SMT) and Green

# **Group 2 Qual Memo:**



TI Information Selective Disclosure

#### Qualification Results Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: TPS74801DRCR	QBS Package Reference: 430F2132IRHBR	QBS Package Reference: BQ24196RGER	QBS Package Reference: BQ294504DRVR	QBS Package Reference: <u>TP S51285BRUKR</u>	QBS Package Reference: TRS3122ERGER
AC	Autoclave 121C	96 Hours	-	3/231/0	3/231/0	3/231/0	3/231/0	3/231/0
ED	Electrical Characterization	Per Datasheet Parameters	Pass	-	-	-	-	Pass
FLAM	Flammability (IEC 695- 2-2)		-	-	-	-	-	3/15/0
FLAM	Flammability (UL 94V- 0)		-	-	-	-	-	3/15/0
FLAM	Flammability (UL-1694)		-	-	-	-	-	3/15/0
HAST	Biased HAST, 130C/85%RH	96 Hours	-	-	-	3/231/0	-	3/231/0
HTOL	Life Test, 150C	300 Hours	-	-	-	-	-	1/77/0
HTSL	High Temp Storage Bake 150C	1000 Hours	-	-	-	-	-	3/231/0
SD	Surface Mount Solderability	Pb Free	-	-	-	-	-	1/22/0
тс	Temperature Cycle, - 65/150C	500 Cycles	-	3/231/0	3/231/0	3/231/0	3/231/0	3/231/0
WBP	Bond Pull	Wires	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0
WBS	Ball Bond Shear	Wires	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0

- QBS: Qual By Similarity Qual Device TPS74801DRCR is qualified at LEVEL2-260C
- Qual Device TPS/74801DRCR is qualified at LEVEL2-260C
   Preconditioning was performed for Autodave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
   The following are equivalent HTOL options based on activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
   The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours
   The following are equivalent Temp Cycle options per JESD47: 55C/125C/700 Cycles and -65C/150C/500 Cycles
   Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status: Qualified Pb-Free(SMT) and Green

# **Group 3 Qual Memo:**



TI Information Selective Disclosure

# Qualification Results Data Displayed as: Number of lots / Total sample size / Total failed

		. ,		•			
Туре	Test Name / Condition	Duration	Qual Device: TP \$62162D\$GR	QBS Package Reference: BQ294504DRVR	QBS Package Reference: OPA2170AIDSGR	QBS Package Reference: <u>TPS53605DSQ</u>	QBS Package Reference: <u>TRS3122ERGER</u>
-	CLHTOL (FF)	125C (1000 Hours), Abs Max (36V)	-	-	-	1/47/0	-
-	CLHTOL (FS)	125C (1000 Hours), Abs Max (36V)	-	-	-	1/33/0	-
-	CLHTOL (SF)	125C (1000 Hours), Abs Max (36V)	-	-	-	1/33/0	-
-	CLHTOL (SS) 125C (1000 Hours), Abs Max (36V)		-	-	-	1/47/0	-
-	Moisture Sensitivity Level, JEDEC	Level 2-260C	3/36/0	-	-	-	-
AC	Autoclave 121C	192 Hours	-	3/231/0	-	-	-
AC	Autoclave 121C	96 Hours	-	3/231/0	-	-	3/231/0
CDM	ESD - CDM	1000 V	-	-	3/9/0	3/9/0	-
CDM	ESD - CDM	1500 V	-	-	2/6/0	2/6/0	1/3/0
CDM	ESD - CDM	250 V	-	-	3/9/0	3/9/0	-
CDM	ESD - CDM	500 V	-	-	3/9/0	3/9/0	-
CDM	ESD - CDM	750 V	-	-	3/9/0	3/9/0	-
DS	Die Shear	QSS 009-009	-	-	-	-	3/30/0
ED	Electrical Characterization	Per Datasheet Parameters	-	-	1/Pass	3/90/0	1/30/0
ED	Electrical Characterization, side by side	-	1/Pass	-	-	-	-
ELFR	Early Life Failure Rate, 125C	48 Hours	-	-	-	3/2999/0	-
FLAM	Flammability (IEC 695-2-2)		-	-	-	-	3/15/0
FLAM	Flammability (UL 94V-0)		-	-	-	-	3/15/0
FLAM	Flammability (UL-1694)		-	-	-	-	3/15/0
HAST	Biased HAST, 110C/85%RH	264 Hours	-	-	-	3/231/0	-
HAST	Biased HAST, 130C/85%RH	192 Hours	-	3/228/0	-	-	-
HAST	Biased HAST, 130C/85%RH	96 Hours	-	3/231/0	3/231/0	-	3/231/0
HBM	ESD - HBM	1000 V	-	-	3/9/0	3/9/0	-
HBM	ESD - HBM	1500 V	-	-	3/9/0	3/9/0	-

Туре	Test Name / Condition	Duration	Qual Device: TPS62162DSGR	QBS Package Reference: BQ294504DRVR	QBS Package Reference: <u>OPA2170AIDSGR</u>	QBS Package Reference: TPS53605DSQ	QBS Package Reference: <u>TRS3122ERGER</u>
HBM	ESD - HBM	2000 V	-	-	3/9/0	3/9/0	-
HBM	ESD - HBM	2500 V	-	-	-	3/9/0	-
HBM	ESD - HBM	3000 V	-	-	3/9/0	-	-
HBM	ESD - HBM	4000 V	-	-	3/9/0	-	1/3/0
HBM	ESD - HBM	500 V	-	-	3/9/0	2/6/0	-
HTOL	Life Test, 125C	1000 Hours	-	-	-	3/231/0	-
HTOL	Life Test, 150C	300 Hours	-	-	-	-	1/77/0
HTSL	High Temp Storage Bake 150C	1000 Hours	-	-	-	-	3/231/0
HTSL	High Temp Storage Bake 170C	70C 420 Hours		-	3/231/0	2/90/0	-
LU	Latch-up	(per JESD78)	-	-	-	-	1/6/0
LU	Latch-up	Latchup/125C	-	-	-	3/18/0	-
LU	Latch-up	Latchup/25c	-	-	1/6/0	-	-
MQ	Manufacturability (Assembly)	(per mfg. Site specification)	3/Pass	3/Pass	-	3/Pass	3/Pass
MQ	Manufacturability (per mfg. Site specification) (Assembly) Request crater check		-	-	3/Pass	-	-
MQ	Manufacturability (Testability - TQ)	(per mfg. Site specification)	-	-	-	-	1/Pass
MSL	Thermal Path Integrity	Level 1-260C	-	3/36/0	-	-	-
MSL	Thermal Path Integrity	Level 2-260C	-	-	-	-	3/36/0
MSL	Thermal Path Integrity, JEDEC, L2	Elec-2/25C	-	-	1/12/0	-	-
MSL	Thermal Path Integrity, JEDEC, L2	Level 2	-	-	2/24/0	-	-
PC	PreCon Level 2	Elec/25C	-	-	3/1249/0	11/815/0	-
PC	PreCon Level 2	Level 2-260C	-	-	-	-	3/1005/0
PD	Physical Dimensions	(per mechanical drawing)	-	-	1/5/0	3/90/0	3/30/0
SD	Pb Free Solderability	Pb Free/Solderability	-	-	-	3/15/0	-
SD	Surface Mount Solderability	Pb Free	-	-	-	-	1/22/0
TC	Temperature Cycle, - 65/150C	1000 Cycles	-	3/231/0	-	-	-
TC	Temperature Cycle, - 65/150C	500 Cycles	-	3/231/0	3/231/0	3/231/0	3/231/0
TC	Temperature Cycle, - 65/150C	750 Cycles	-	3/231/0	3/231/0	-	-
UHAST	Unbiased HAST 110C/85%RH	264 Hours	-	-	-	3/231/0	-
UHAST	Unbiased HAST 130C/85%RH	96 Hours	-	-	3/231/0	-	-

Туре	Test Name / Condition	Duration	Qual Device: TP \$62162D\$GR	QBS Package Reference: BQ294504DRVR	QBS Package Reference: OPA2170AIDSGR	QBS Package Reference: TP S53605DSQ	QBS Package Reference: TRS3122ERGER
VM	Visual / Mechanical	(per mfg. Site specification)	-	-	-	-	3/984/0
VM	Visual Quality Reliability Inspection	Post 1000 Cycles Temp Cycle	-	3/6/0	-	-	-
VM	Visual Quality Reliability Inspection	Post 192 Hours HAST	-	3/6/0	-	-	-
VM	Visual Quality Reliability Inspection	Post 96 Hours HAST	-	3/6/0	-	-	-
VM	Visual Quality Reliability Inspection	Post Autoclave	-	-	-	-	3/Pass
VM	Visual Quality Reliability Inspection	Post Temp Cycle	-	-	-	-	3/Pass
WBP	Bond Pull	36 leads, 5 units/lot	-	-	-	3/228/0	-
WBP	Bond Pull	76 Wire, 3 units min	-	-	-	-	3/228/0
WBP	Bond Pull	Wires	3/228/0	3/228/0	-	-	-
WBS	Ball Bond Shear	36 leads, 5 units/lot	-	-	-	3/228/0	-
WBS	Ball Bond Shear	76 balls, 3 units min	-	-	-	-	3/228/0
WBS	Ball Bond Shear	Wires	3/228/0	3/228/0	-	-	-
XRAY	X-ray	(top side only)	-	-	-	-	3/15/0

<sup>-</sup> QBS: Qual By Similarity
- Qual Device TPS62162DSGR is qualified at LEVEL2-260CG
- Preconditioningwas performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options perJESD47:-55C/125C/700 Cycles and-65C/150C/500 Cycles
- Quality and Environmental data is available at TI's external Web site: http://www.ti.com/
- Green/Pb-free Status:
- Qualified Pb-Free(SMT) and Green

## **Group 4 Qual Memo:**



Selective Disclosure

#### Qualification Results Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: TPS51916RUKR	QBS Package Reference: BQ294504DRVR	QBS Package Reference: <u>TPS51285BRUKR</u>	QBS Package Reference: <u>TPS53605DSQ</u>	QBS Package Reference: <u>TRS3122ERGER</u>
AC	Autoclave 121C	96 Hours	-	3/231/0	3/231/0	-	3/231/0
ED	Electrical Characterization	Per Datasheet Parameters	Pass	-	-	Pass	Pass
FLAM	Flammability (IEC 695-2-2)		-	-	-	-	3/15/0
FLAM	Flammability (UL 94V-0)		-	-	-	-	3/15/0
FLAM	Flammability (UL-1694)		-	-	-	-	3/15/0
HAST	Biased HAST, 110C/85%RH	264 Hours	-	-	-	3/231/0	-
HAST	Biased HAST, 130C/85%RH	96 Hours	-	3/231/0	-	-	3/231/0
HTOL	Life Test, 125C	1000 Hours	-	-	-	3/231/0	-
HTOL	Life Test, 150C	300 Hours					1/77/0
HTSL	High Temp Storage Bake 170C	420 Hours	-	-	-	2/90/0	3/231/0
SD	Pb Free Solderability	Pb Free/Solderability	-	-	-	3/15/0	1/22/0
TC	Temperature Cycle, - 65/150C	500 Cycles	-	3/231/0	3/231/0	3/231/0	3/231/0
UHAST	Unbiased HAST 110C/85%RH	264 Hours	-	-	-	3/231/0	-
WBP	Bond Pull	Wires	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0
WBS	Ball Bond Shear	Wires	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0

- QBS: Qual By Similarity Qual Device TPS51916RUKR is qualified at LEVEL2-260CG
- Preconditioning was performed for Autodave, Unbiased HAST, THB/Biased HAST, Temperature Cyde, Thermal Shock, and HTSL, as applicable
   The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status: Qualified Pb-Free(SMT) and Green

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